

20-2125

ELASTOMERIC POTTING & ENCAPSULATING COMPOUND

DESCRIPTION:

20-2125 is formulated for electronic potting, encapsulating and casting applications. The 20-2125 is a two-component, low viscosity, room temperature curing system. This is an easy-to-use product that does not contain TDI, MbOCA or Mercury. 20-2125 will cushion and protect sensitive electronic components. It will impart very little stress on components during cure or thermal cycling.

A unique feature of this product is the ability to modify the hardness by simply changing the mix ratio of Polyol and Isocyanate. **A hardness range of Shore A 20 to 80 is possible with the 20-2125.**

The base Natural Oil Polyol (NOP) used in 20-2125 is obtained directly from a plant source without chemical modifications. Due to the raw materials selected, this product is low in toxicity and considered a **GREEN** potting compound. Using renewable resources such as NOPs will reduce the demand on non-renewable fossil fuels and reduce the overall production of carbon dioxide.

FEATURES:

- Low Toxicity
- Adjustable Hardness
- **Green**
- Low Viscosity
- Low Durometer
- Moisture Resistant
- Low Shrinkage & Exotherm

BENEFITS:

- Reduce employee exposure to dangerous chemicals
- Durometer can be modified for different applications
- Reduce demand on non-renewable fossil fuels
- Quick self-leveling around components
- Low stress on components & vibration resistant
- Can be used in wet environments
- Will not damage components during cure

TYPICAL PROPERTIES:

Viscosity, 25°C, cps	
Polyol	800
Isocyanate	3,000
Color	Clear/Amber or Black
Specific gravity, 25°C	
Polyol	0.96
Isocyanate	1.15
Operating Temperature Range, °C	-30 to +125
Thermal conductivity, W/m-K	0.3

Mix Ratio by weight (Polyol:Iso)	240:100	220:100	185:100	150:100
Mix Ratio by volume (Polyol:Iso)	285:100	260:100	220:100	180:100
Hardness, Shore A	25	35	55	80
Pot life, Minutes				
25°C	35	30	25	20
60°C	8	8	8	8
Elongation, %	295	230	225	250
Tensile strength, psi	155	170	530	1750
Tear strength, ASTM 624 C pli	15.0	18.0	38.0	89.0
Split tear, ASTM 1938 pli	5.0	6.0	12.0	34.0
Linear shrinkage, in./in.	0.012	0.013	0.014	0.014
Dielectric strength, V/mil	493	512	506	500
Volume resistivity, ohm-cm	9.5x10 ¹⁰	1.4x10 ¹¹	2.8x10 ¹¹	4.1x10 ¹¹
Surface resistivity, 25°C, ohm	2.8x10 ¹²	5.9x10 ¹²	5.6x10 ¹²	2.4x10 ¹³
Dielectric constant, 1 kHz	5.8	5.8	5.8	5.5
Dissipation factor, 1 kHz	0.055	0.072	0.098	0.072

INSTRUCTIONS FOR USE:

1. By weight, thoroughly mix according to one of the mix ratio schedules provided in the above table. Two components should be carefully weighed in metal, plastic or glass containers. Avoid using paper cups and wooden stirrers.
2. Mixed material can be degassed at 29 in Hg to ensure bubble free castings. Containers should be large enough to allow frothing.
3. Cure according to one of the following cure schedules:
 - a) 25°C 24 Hours
 - b) 45°C 2.5 Hours
 - c) 65°C 1.5 Hours
 - d) 85°C 40 Minutes

Final cured hardness will take 5-7 days at room temperature.

STORAGE & HANDLING & SAFETY:

Store both components at 75-85°F in original containers. If the containers are opened and the contents partially used, the material left in the container should be blanketed with dry nitrogen before sealing.

Please read the Safety Data Sheet before using this or any other chemical.

AVAILABILITY:

These products are available in quarts, gallons, 5-gallon pails and 55-gallon drums.



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